

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3819263

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
WOJCIECH GIZIEWICZ	01/21/2014
ALEXANDER EICHLER-NEUMANN	01/10/2014
ULRICH KEIL	01/20/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	FCI ASIA PTE. LTD.
<b>Street Address:</b>	159 KAMPONG AMPAT
<b>Internal Address:</b>	#04-01/04 KA PLACE
<b>City:</b>	SINGAPORE
<b>State/Country:</b>	SINGAPORE
<b>Postal Code:</b>	368328
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15027711
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(215)568-3439
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	215-568-3100
<b>Email:</b>	assignments@woodcock.com
<b>Correspondent Name:</b>	BAKER & HOSTETLER LLP
<b>Address Line 1:</b>	CIRA CENTRE, 12TH FLOOR
<b>Address Line 2:</b>	2929 ARCH STREET
<b>Address Line 4:</b>	PHILADELPHIA, PENNSYLVANIA 19104-2891
<b>ATTORNEY DOCKET NUMBER:</b>	100148.003799 / C5076
<b>NAME OF SUBMITTER:</b>	VALERIE CHICCHI
<b>SIGNATURE:</b>	/Valerie Chicchi/
<b>DATE SIGNED:</b>	04/07/2016
<b>Total Attachments: 6</b>	
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ASSIGNMENT

WHEREAS, I, Wojciech Giziewicz, citizen of Canada, c/o c/o FCI, Holzhauser Strasse 175-177, 13509 Berlin, Germany, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application identified as Application Number 61/888,941 filed October 9, 2013 ("the invention"), which is entitled BEAM SPLITTING FOR LASER POWER MONITORING IN MOLDED OPTICAL COUPLING UNITS ("the subject application").

AND WHEREAS, FCI ASIA PTE. LTD., at 159 Kampong Ampat, #04-01/04 KA Place, Singapore 368328, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the international Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors,

Wb

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legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 21<sup>st</sup> day of January, year of 2014.

W. Giziewicz  
Signature  
Wojciech Giziewicz

\*\*\*\*\*

STATEMENT OF WITNESS

SIGNED at Berlin, Germany  
(City) (Country)

This 21 day of January, 2014.

I, Andrey Lysov whose full  
residence address is Kleine Alexanderstrasse 9, 10178 Berlin

was personally present and did see Wojciech Giziewicz execute the above assignment on the 21 day of January, 2014, and such assignor is personally known to me to be the person described in such document.

[Signature]  
Signature of Witness

W.G.

ASSIGNMENT

WHEREAS, I, Alexander Eichler-Neumann, citizen of Germany, c/o FCI, Holzhauser Strasse 175-177, 13509 Berlin, Germany, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application identified as Application Number 61/888,941 filed October 9, 2013 ("the invention"), which is entitled BEAM SPLITTING FOR LASER POWER MONITORING IN MOLDED OPTICAL COUPLING UNITS ("the subject application").

AND WHEREAS, FCI ASIA PTE. LTD., at 159 Kampong Ampat, #04-01/04 KA Place, Singapore 368328, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, and describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents; including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors,

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legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 10 day of January, year of 2014.



Signature  
Alexander Eichler-Neumann

\*\*\*\*\*

STATEMENT OF WITNESS

SIGNED at Berlin

(City) (Country)

This 10 day of January, 2014.

I, Sven Klischick

whose full

residence address is Holsteinische Str. 28, 10717 Berlin

was personally present and did see Alexander Eichler-Neumann execute the above assignment on the 10 day of January, 2014 and such assignor is personally known to me to be the person described in such document.



Signature of Witness

**ASSIGNMENT**

WHEREAS, I, Ulrich Keil, citizen of Germany, c/o FCI, Holzhauser Strasse 175-177, 13509 Berlin, Germany, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application identified as Application Number 61/888,941 filed October 9, 2013 ("the invention"), which is entitled **BEAM SPLITTING FOR LASER POWER MONITORING IN MOLDED OPTICAL COUPLING UNITS** ("the subject application").

AND WHEREAS, FCI ASIA PTE. LTD., at 159 Kampong Ampat, #04-01/04 KA Place, Singapore 368328, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

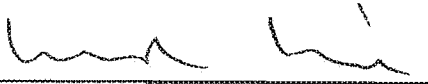
AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors,

legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 20<sup>th</sup> day of January, year of 2014



Signature

Ulrich Keil

\*\*\*\*\*

STATEMENT OF WITNESS

SIGNED at Berlin, Germany

(City)

(Country)

This 20<sup>th</sup> day of January, 2014.

I, chenhui Jiang whose full

residence address is Schiller str. 18, 10625, Berlin, Germany.

was personally present and did see Ulrich Keil execute the above assignment on the 20<sup>th</sup> day of January, 2014, and such assignor is personally known to me to be the person described in such document.



Signature of Witness